

ACUROS® CQD® 1920 USB3 SWIR Camera

ACUROS-1920-USB3-001

The ACUROS CQD SWIR cameras are sensitive to wavelengths from 400 nm to 1700 nm and feature up to 1920 x 1080 resolution with 15 μ m pixels to enable high performance at the lowest cost. The camera features low noise, highly stable performance, and up to 10 dB higher SNR compared to the competition's 5 μ m pixel InGaAs cameras. It supports a range of applications, including industrial inspection, military intelligence, and advanced research, offering versatility and outstanding image quality for both low-cost and high-performance applications.

Please see the ACUROS eSWIR product line for expanded sensitivity capabilities from 400 nm to 2000 nm.

SPECIFICATIONS

Table 1. ELECTRO-OPTICAL SPECIFICATIONS

Parameter	Value/Description
Sensor	ACUROS CQD sensor
Temperature Stabilization	Single-stage thermo-electric cooler
Sensor Array Format	1920 x 1080
Resolution	2.07 MP (megapixel)
Spectral Band	400–1700 nm
Array Size	28.8 mm x 16.2 mm, 33 mm diagonal
Pixel Pitch	15 μ m x 15 μ m
Max Frame Rate at Full Resolution	58 fps (8, 10, 12, 14 bit)
Pixel Operability	99.9% typical, 99.75% min
Bit Depth	8, 10, 12, 14 bit selectable
Integration Type	Snapshot global shutter
Trigger	External TTL
Integration Time	100 μ s to 30 ms
Dynamic Range	70 dB typical
Windowing & Windowing Frame Rate	Array centered. Scales inversely to window size
Laser Beam Fringeless Operation	No (See ACUROS laser series cameras)
Binning Arrays	2 x 2, 4 x 4
Non-uniformity Correction	2-point non-uniformity correction
Temporal Dark Noise	80/70/65 e ⁻ typical
Quantum Efficiency	See typical QE curve (Figure 4)



ORDERING INFORMATION

Part Number
ACUROS-1920-USB3-001

Features

- Full HD Resolution
- TEC Cooling
- Low Noise
- Fast Frame Rate
- Visible-SWIR
- USB3 Vision

Applications

- Machine Vision
- Silicon Inspection
- Automotive
- Fill-level
- Surveillance
- Hyperspectral
- Chemical Sensors
- Agricultural
- Medical Imaging
- Thermography

Table 2. ENVIRONMENTAL & POWER SPECIFICATIONS, TYPICAL PERFORMANCE

Parameter	Value/Description
Operating Case Temperature	–20 °C to +55 °C
Power Consumption	6.5–12 W depending on TEC settings
Power Supply Voltage	6–16 V dc
Regulatory Compliance	CE mark

Table 3. MECHANICAL SPECIFICATIONS

Parameter	Value/Description
Dimensions Excluding Lens	6.1 x 6.1 x 10.3 cm (C-mount)
Weight Excluding Lens	600 grams with C-mount adapter
Lens Mounts	F, M42 (C-mount flange-back distance)
Power Connector	Hirose 12-pin, HR10A-10R-12PB (71)
Trigger Connector	BNC

Table 4. SOFTWARE AND USER INTERFACE

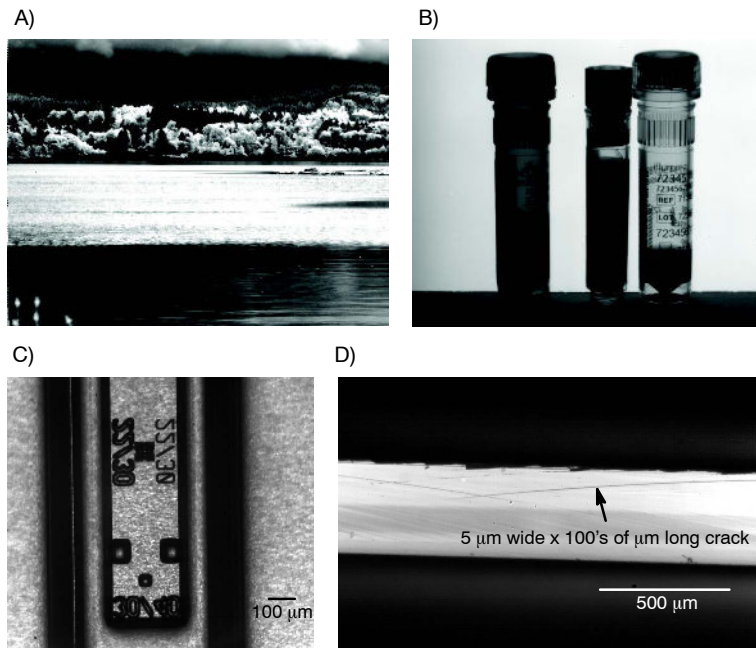
Parameter	Value/Description
Software Development Kit	Windows GUI & Pleora eBUS SDK (Linux, Windows, macOS)
GenICam Compliance	Yes
Interface	USB3 Vision



Figure 1. C-mount, F-mount, and M-42 Lens Mounts



Figure 2. USB3 Vision Interface



- A) ACUROS 640: imaging through maritime rain event
 B) ACUROS 640: imaging through pharmaceutical vial labels
 C) ACUROS 1280: alignment mark in bonded wafers
 D) ACUROS 1920: mag image of semiconductor chip edge

Figure 3. ACUROS CQD SWIR Camera Images

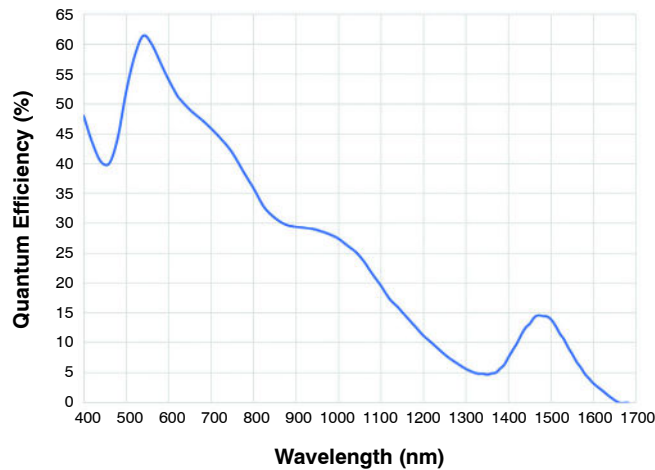
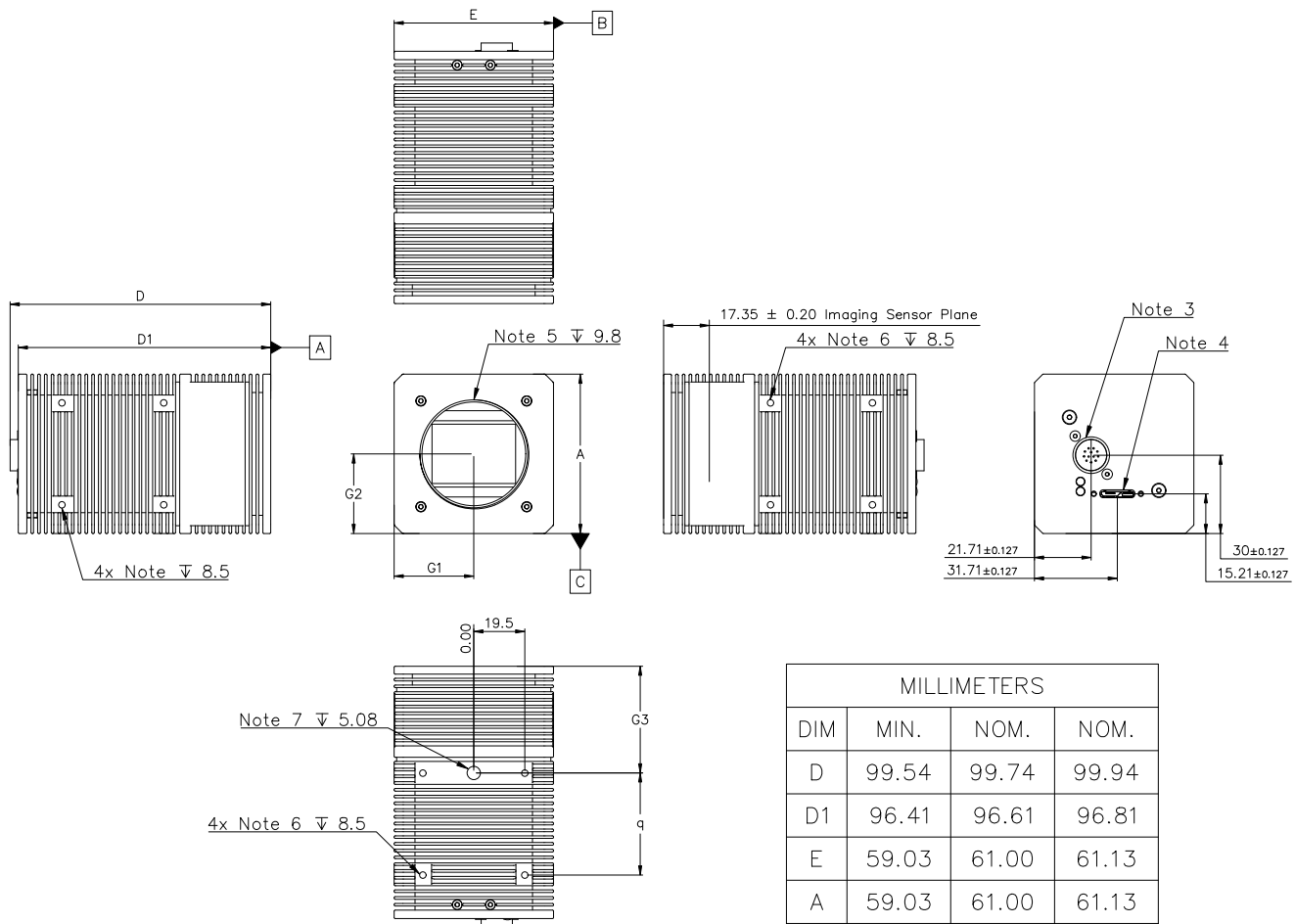


Figure 4. Typical QE Performance

CMOD 99.74x61.00x61.00
CASE 810AB
ISSUE O

DATE 16 OCT 2024



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETER
3. HIROSE 12 PIN CONNECTOR
4. USB 3.0 Micro-B
5. M42-MOUNT ∇ 9.8
6. M3X0.5 DEPTH ∇ 8.5
7. 1/4-20 UNC DEPTH ∇ 5.08

MILLIMETERS			
DIM	MIN.	NOM.	NOM.
D	99.54	99.74	99.94
D1	96.41	96.61	96.81
E	59.03	61.00	61.13
A	59.03	61.00	61.13
G1	30.37	30.50	30.63
G2	30.37	30.50	30.63
G3	40.63	40.83	41.03
q	38.98	39.11	39.24
q1	19.37	19.50	19.63

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